

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	YOSHIKATSU TOKUDA	02/05/2020
RECEIVING PARTY DATA		
Name:	TOPCON CORPORATION	
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PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16798250
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DATE SIGNED:	02/21/2020	
Total Attachments: 2		
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ASSIGNMENT AND AGREEMENT

For value received, I, **Yoshikatsu Tokuda of Itabashi-ku, Tokyo, Japan** hereby sell, assign and transfer to **TOPCON CORPORATION**, a corporation of the Country of Japan, having a business address at 75-1, Hasunuma-cho, Itabashi-ku, Tokyo 1748580, Japan and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **"DISTANCE MEASURING DEVICE"**, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to **TOPCON CORPORATION** the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize **TOPCON CORPORATION** to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of **TOPCON CORPORATION** to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to **TOPCON CORPORATION** in the United States and in all countries foreign to the United States, or to such nominees as **TOPCON CORPORATION** may designate.

I agree that, when requested, I shall, without charge to TOPCON CORPORATION but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Yoshikatsu Tokuda
Yoshikatsu Tokuda

Feb 5, 2020
Date

Mitsuharu Yamada
Witness Signature

Feb 5, 2020
Date

Mitsuharu YAMADA
Print name of witness